Specifications Absolute Maximum Ratings at Ta = 25°C, V_{SS} = 0 V

Parameter	Symbol	Conditions	Ratings	Unit				
	V _{DD} max	V _{DD}	-0.3 to +7.0	V				
Maximum supply voltage	V _{LCD} max	V _{LCD}	-0.3 to +7.0	V				
	V _{IN} 1	CE, CL, DI, INH	-0.3 to +7.0					
Input voltage	V _{IN} 2	OSC	–0.3 to V _{DD} +0.3	V				
	V _{IN} 3	V _{LCD} 1, V _{LCD} 2	-0.3 to V _{LCD} +0.3	.3				
Output valtage	VOUT1	OSC	–0.3 to V _{DD} +0.3	V				
Output voltage	V _{OUT} 2	S1 to S22, COM1 to COM4, P1 to P4	–0.3 to V _{LCD} +0.3	v				
	IOUT1	S1 to S22	300	μA				
Output current	IOUT2	COM1 to COM4	3					
	IOUT3	P1 to P4	5	mA				
Allowable power dissipation	Pd max	Ta = 85°C	100	mW				
Operating temperature	Topr		-40 to +85	°C				
Storage temperature	Tstg		–55 to +125	°C				

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Allowable Operating Ranges at Ta = –40 to +85°C, V_{SS} = 0 V

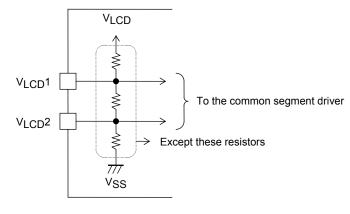
Devenueter	Currents of	Canditia		Ratings						
Parameter	Symbol	Condition	ns	min	typ	max	Unit			
Cuertu veltere	V _{DD}	V _{DD}		2.7		6.0	V			
Supply voltage	V _{LCD}	V _{LCD}		2.7		6.0	v			
Innut voltage	V _{LCD} 1	V _{LCD} 1			2/3V _{LCD}	V _{LCD}	V			
Input voltage	V _{LCD} 2	V _{LCD} 2			1/3V _{LCD}	V _{LCD}	v			
Input high-level voltage	VIH	CE, CL, DI, INH		0.8V _{DD}		6.0	V			
Input low-level voltage	VIL	CE, CL, DI, INH		0		0.2V _{DD}	V			
Recommended external resistor	Rosc	OSC			43		kΩ			
Recommended external capacitor	Cosc	OSC			680		pF			
Oscillation guaranteed range	fosc	OSC		25	50	100	kHz			
Data setup time	tds	CL, DI	[Figure 2]	160			ns			
Data hold time	tdh	CL, DI	[Figure 2]	160			ns			
CE wait time	tcp	CE, CL	[Figure 2]	160			ns			
CE setup time	tcs	CE, CL	[Figure 2]	160			ns			
CE hold time	tch	CE, CL	[Figure 2]	160			ns			
High-level clock pulse width	tφH	CL	[Figure 2]	160			ns			
Low-level clock pulse width	tφL	CL	[Figure 2]	160			ns			
Rise time	tr	CE, CL, DI	[Figure 2]		160		ns			
Fall time	tf	CE, CL, DI	[Figure 2]		160		ns			
INH switching time	tc	ĪNH, CE	[Figure 3]	10			μS			

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

Deveneter	Cumphiel	Pin	Conditions	Ratings						
Parameter	Symbol	Pin	Conditions	min	typ	max	Unit			
Hysteresis width	V _H	CE, CL, DI, INH			0.1V _{DD}		V			
Input high-level current	Ιн	CE, CL, DI, INH	V _I = 6.0 V			5.0	μA			
Input low-level current	١ _{١L}	CE, CL, DI, INH	V _I = 0 V	-5.0			μA			
Output high-level	V _{OH} 1	S1 to S22	I _O = -20 μA	V _{LCD} -0.9						
voltage	V _{OH} 2	COM1 to COM4	I _O = -100 μA	V _{LCD} -0.9			V			
	V _{OH} 3	P1 to P4	I _O = –1 mA	V _{LCD} -0.9						
Output low-level	V _{OL} 1	S1 to S22	I _O = 20 μA			0.9				
voltage	V _{OL} 2	COM1 to COM4	I _O = 100 μA			0.9	V			
	V _{OL} 3	P1 to P4	I _O = 1 mA			0.9				
Output middle- level voltage	V _{MID} 1	COM1 to COM4	1/2 bias, $I_O = \pm 100 \ \mu A$	1/2V _{LCD} -0.9		1/2V _{LCD} +0.9				
*1	V _{MID} 2	S1 to S22	1/3 bias, I _O = ±20 μA	2/3V _{LCD} _0.9		2/3V _{LCD} +0.9				
	V _{MID} 3	S1 to S22	1/3 bias, I _O = ±20 μA	1/3V _{LCD} _0.9		1/3V _{LCD} +0.9	V			
	V _{MID} 4	COM1 to COM4	1/3 bias, I _O = ±100 μA	2/3V _{LCD} -0.9		2/3V _{LCD} +0.9				
	V _{MID} 5	COM1 to COM4	1/3 bias, I _O = ±100 μA	1/3V _{LCD} _0.9		1/3V _{LCD} +0.9				
Oscillator frequency	fosc	OSC	Rosc = 43 kΩ Cosc = 680 pF	40	50	60	kHz			
Supply current	I _{DD} 1	V _{DD}	Power saving mode			5				
	I _{DD} 2	V _{DD}	V _{DD} = 6.0 V, output open, fosc = 50 kHz		230	460				
	ILCD1	I _{LCD} 1 V _{LCD} Power saving mode								
	I _{LCD} 2	V _{LCD}	V _{LCD} = 6.0 V, output open, 1/2 bias, fosc = 50 kHz		100	200	μA			
	I _{LCD} 3	VLCD	V _{LCD} = 6.0 V, output open, 1/3 bias, fosc = 50 kHz		60	120				

Electrical Characteristics at Allowable Operating Ranges

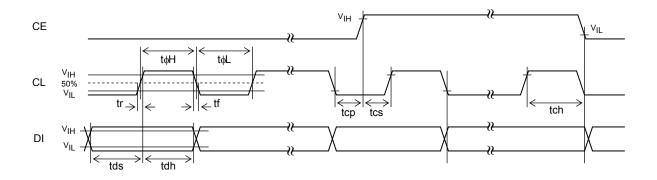
Note: *1 Excluding the bias voltage generation divider resistors built into	VLCD1, VLCD2. (See Figure 1.)
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Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1. When CL is stopped at the low level



2. When CL is stopped at the high level

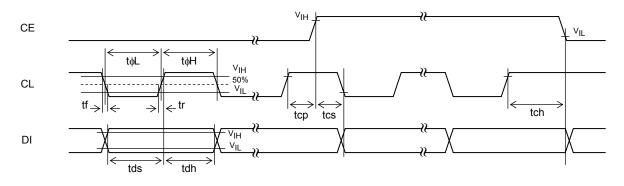
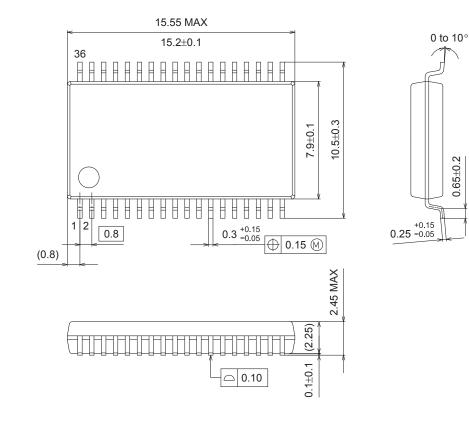


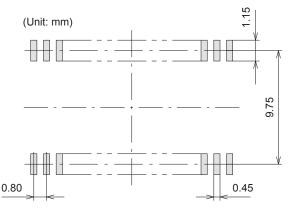
Figure 2

Package Dimensions unit : mm

SOIC36 W / MFP36SDJ (375 mil) CASE 751CM ISSUE A



SOLDERING FOOTPRINT*



NOTE: The measurements are not to guarantee but for reference only.

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.





XXXXX = Specific Device Code Y = Year

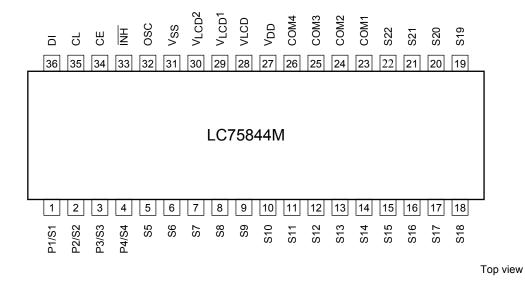
M = Month

DDD = Additional Traceability Data

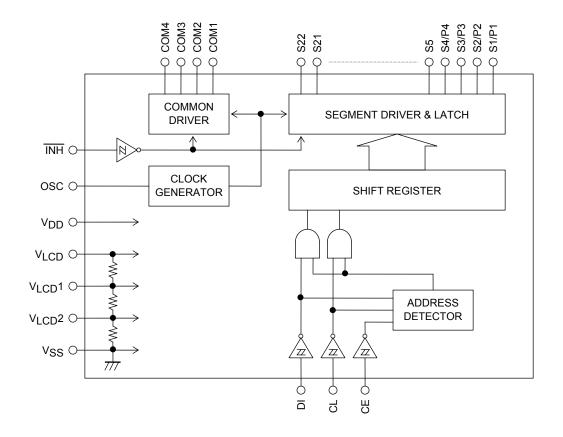
*This information is generic.

Pb-Free indicator, "G" or microdot "■", may or may not be present.

Pin Assignment



Block Diagram



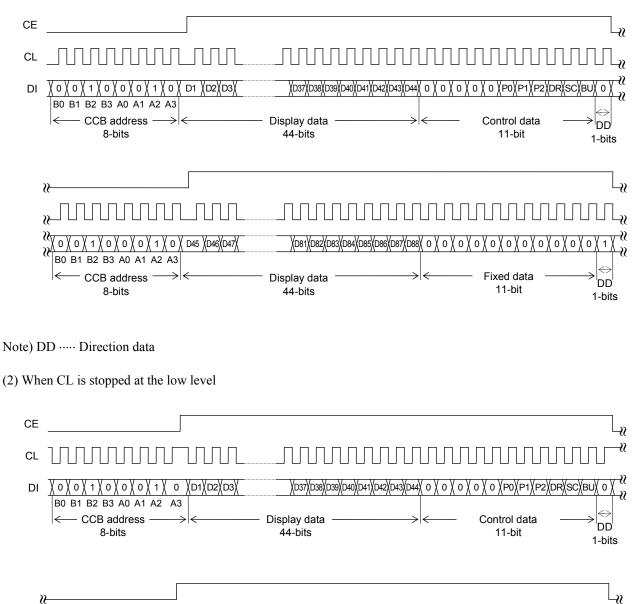
Downloaded from Arrow.com.

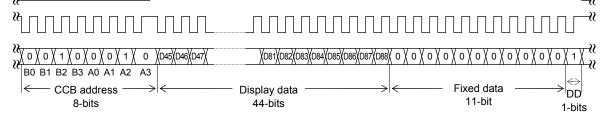
Pin Functions

Symbol	Pin No.	Function	Active	I/O	Handling when unused
S1/P1 to S4/P4 S5 to S22	1 to 4 5 to 22	Segment outputs for displaying the display data transferred by serial data input. The S1/P1 to S4/P4 pins can be used as general-purpose output ports under serial data control.	-	0	OPEN
COM1 to COM4	23 to 26	Common driver outputs The frame frequency (fo) is given by: fo=(fosc/512) Hz.	-	0	OPEN
OSC	32	Oscillator pin, which, together with externally connected resistor and capacitor, makes up an oscillator circuit.	-	I/O	V _{DD}
CE CL DI	34 35 36	Serial data transfer input pin to be connected to the controller. CE: Chip enable CL: Synchronization clock DI: Transfer data	H 	 	GND
ĪNH	33	$\begin{array}{cccc} \mbox{Display off input pin} & & \\ \bullet \end{tabular} \begin{tabular}{lllllllllllllllllllllllllllllllllll$	L	I	GND
V _{LCD} 1	29	Used for applying the LCD driver $2/3$ bias voltage externally. Must be connected to V _{LCD} 2 when a $1/2$ bias scheme is used.	-	I	OPEN
V _{LCD} 2	30	Used for applying the LCD driver $1/3$ bias voltage externally. Must be connected to V _{LCD} 1 when a $1/2$ bias scheme is used.	-	I	OPEN
V _{DD}	27	Logic block power supply pin to provide a voltage between 2.7 V to 6.0 V.	-	-	-
V _{LCD}	28	LCD driver power supply pin to provide a voltage between 2.7 V to 6.0 V.	-	-	-
V _{SS}	31	Power supply pin to connect to ground.	-	-	-

Serial Data Transfer Form

(1) When CL is stopped at the low level





Note) DD Direction data

- CCB address ·· "44H"
- D1 to D88 ····· Display data
- P0 to P2 Segment output port / general-purpose output port switching control data
- SC ····· Segment ON, OFF control data
- BU ····· Normal mode, power save mode control data

Example of Serial Data Transfer

• When used with 45 segments or more Serial data must be transferred all 112-bit.

8-bit	56-bit
← 0 0 1 0 0 0 1 0 B0 B1 B2 B3 A0 A1 A2 A3	D37 D38 D39 D40 D41 D42 D43 D44 0 0 0 0 0 0 P0 P1 P2 DR SC BU 0
0 0 1 0 0 1 0 D45 D46 D47 B0 B1 B2 B3 A0 A1 A2 A3	D81 D82 D83 D84 D85 D86 D87 D88 0 1

• When fewer than 45 segments are used, only 56-bits of serial data need to be sent. However, the display data D1 to D44 and the control data must be sent.

				1	B-bit																56-b	it										
									< >																							
\leftarrow	0	0	1	0	0	0	1	0	Н	D1	D2	D3		D37	7 D38	D39	D40	D41	D42	D43	3 D44	0	0	0	0	0	P0	P1	P2	SC	вU	0
	B0	B1	B2	B3	A0	A1	A2	A3																								

Note) When fewer than 45 segments are used, transfers such as that shown in the figure below cannot be used.

8-bit	56-bit	
← 0 0 1 0 0 0 1 0 D45 D46 D47	D81 D82 D83 D84 D85 D86 D87 D88 O	0 0 1
B0 B1 B2 B3 A0 A1 A2 A3		

Control Data Description

(1) P0 to P2 Segment output port/General-purpose output port switching control data

This control data switching output S1/P1 to S4/P4 segment output port and general-purpose output port.

	Control data	1		Output	oin state		
P0	P1	P2	S1/P1	S2/P2	S3/P3 S4/P4		
0	0	0	S1	S2	S3	S4	
0	0	1	P1	S2	S3	S4	
0	1	0	P1	P2	S3	S4	
0	1	1	P1	P2	P3	S4	Note) Sn (n=1 to 4): Segment output port
1	0	0	P1	P2	P3	P4	Pn (n=1 to 4): General-purpose output por

The following shows the correspondence between output pins and display data when the general-purpose output port is selected.

Output pin	Correspondence display data
S1/P1	D1
S2/P2	D5
S3/P3	D9
S4/P4	D13

For example, if output pin S4/P4 is for the general-purpose output port, output pin S4/P4 outputs high and low-level when display data D13="1" and D13= "0", respectively.

(2) DR 1/2 bias drive, 1/3 bias driver switching control data

This control data switching LCD 1/2 bias driver and 1/3 bias driver.

DR	Driver method
0	1/3 bias driver
1	1/2 bias driver

(3) SC ····· Segment ON, OFF control data

This control data controls segment ON and OFF.

SC	Display state					
0	ON					
1	OFF					

Note: that the OFF state with SC=[1] corresponds to the OFF state due to output of the display OFF waveform from the segment output pin.

(4) BU Normal mode, Power save mode control data

This control data controls normal mode and power save mode.

BU	Mode
0	Normal mode
1	Power save mode (oscillation on the OSC pin stops and the common, segment output pins go low, However, output pins S1/P1 to S4/P4 can be used as the general-purpose output port by the use of control data P0 to P2.)

Display data and output pin correspondence

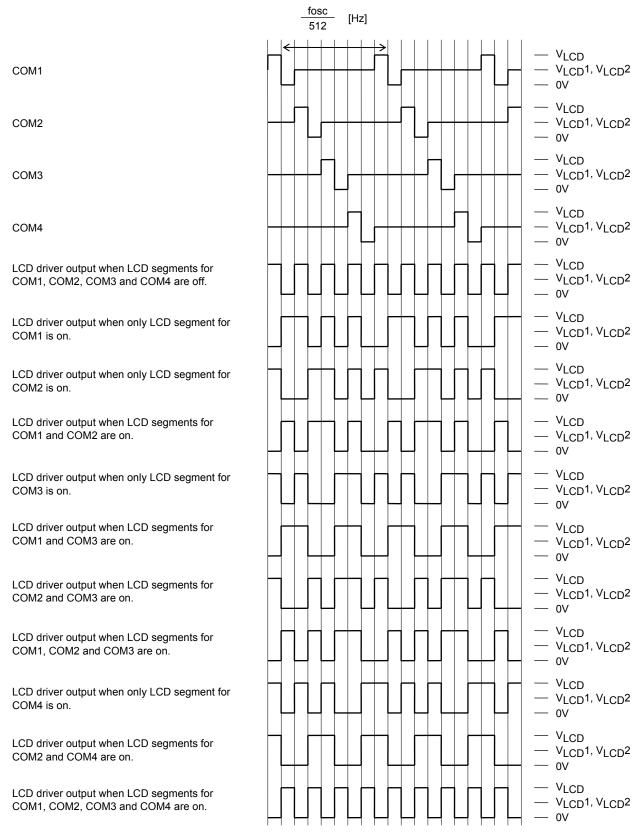
Output pin	COM1	COM2	COM3	COM4	Output pin	COM1	COM2	COM3	COM4
S1/P1	D1	D2	D3	D4	\$12	D45	D46	D47	D48
S2/P2	D5	D6	D7	D8	S13	D49	D50	D51	D52
S3/P3	D9	D10	D11	D12	S14	D53	D54	D55	D56
S4/P4	D13	D14	D15	D16	S15	D57	D58	D59	D60
S5	D17	D18	D19	D20	S16	D61	D62	D63	D64
S6	D21	D22	D23	D24	S17	D65	D66	D67	D68
S7	D25	D26	D27	D28	S18	D69	D70	D71	D72
S8	D29	D30	D31	D32	S19	D73	D74	D75	D76
S9	D33	D34	D35	D36	S20	D77	D78	D79	D80
S10	D37	D38	D39	D40	S21	D81	D82	D83	D84
S11	D41	D42	D43	D44	S22	D85	D86	D87	D88

Note: Output pins S1/P1 to S4/P4 are for segment output port selection.

For example, the data to output pin correspondence for the output pin S11 is as follows.

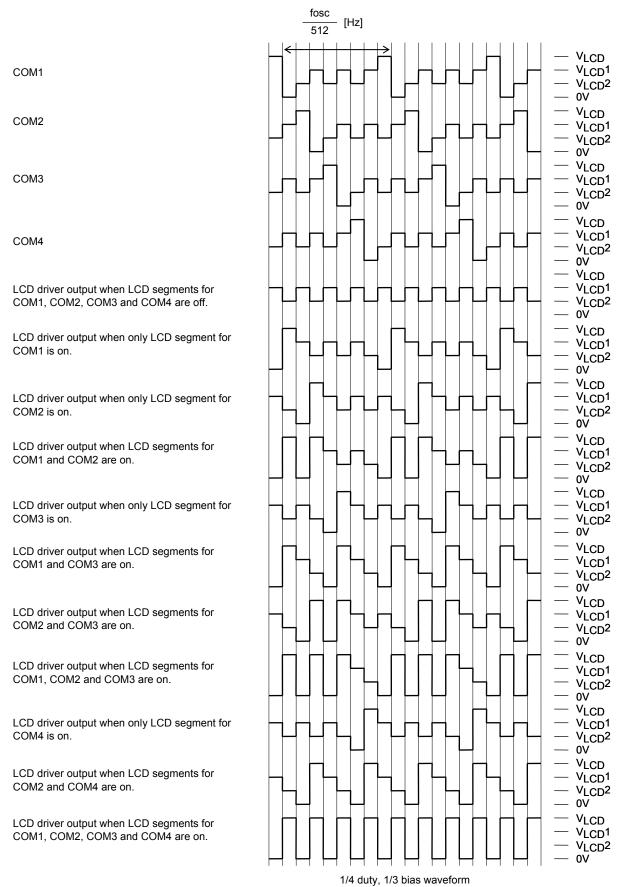
Display data			Octored air (044) state		
D41	D42	D43	D44	Output pin (S11) state	
0	0	0	0	LCD segments for COM1, COM2, COM3 and COM4 OFF	
0	0	0	1	LCD segment for COM4 ON	
0	0	1	0	LCD segment for COM3 ON	
0	0	1	1	LCD segments for COM3 and COM4 ON	
0	1	0	0	LCD segment for COM2 ON	
0	1	0	1	LCD segments for COM2 and COM4 ON	
0	1	1	0	LCD segments for COM2 and COM3 ON	
0	1	1	1	LCD segments for COM2, COM3 and 4 ON	
1	0	0	0	LCD segment for COM1 ON	
1	0	0	1	LCD segments for COM1 and COM4 ON	
1	0	1	0	LCD segments for COM1 and COM3 ON	
1	0	1	1	LCD segments for COM1, 3 and COM4 ON	
1	1	0	0	LCD segments for COM1 and COM2 ON	
1	1	0	1	LCD segments for COM1, COM2 and COM4 ON	
1	1	1	0	LCD segments for COM1, COM2 and COM3 ON	
1	1	1	1	LCD segments for COM1, COM2, COM3 and COM4 ON	

Output Waveforms (1/4-Duty 1/2-Bias ON System)



1/4 duty, 1/2 bias waveform

Output Waveforms (1/4-Duty 1/3-Bias ON System)



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INH and Display Control

Since the IC internal data (D1 to D88, control data) is undefined immediately after applying power, hold $\overline{\text{INH}}$ low at same time as applying power to turn off the display (S1/P1 to S4/P4, S5 to S22, COM1 to COM4 \cdots VSS level), and serial transfer data from the microprocessor during the period that $\overline{\text{INH}}$ is low.

When the data transfer is complete, set INH high.

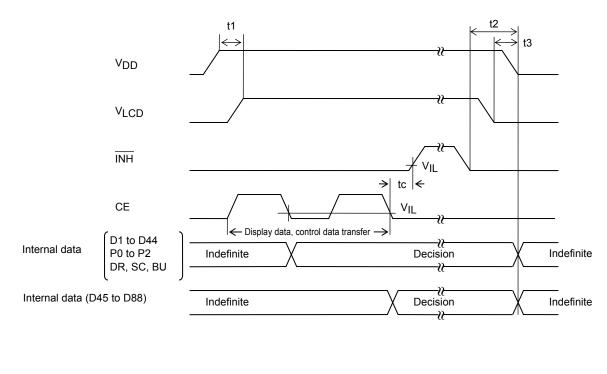
This procedure will avoid displaying meaningless patterns at startup. (See Figure 3)

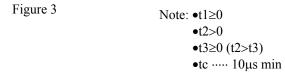
Power Sequence

Be sure to observe the following sequence for power ON/OFF (See Figure 3)

- Power ON: Logic block power (V_{DD}) ON \rightarrow LCD driver power (V_{LCD}) ON
- Power OFF: LCD driver power (V_{LCD}) OFF \rightarrow Logic block power (V_{DD}) OFF

When the logic block power (V_{DD}) and LCD driver power (V_{LCD}) are common, both power supplies can be turned ON/OFF simultaneously.



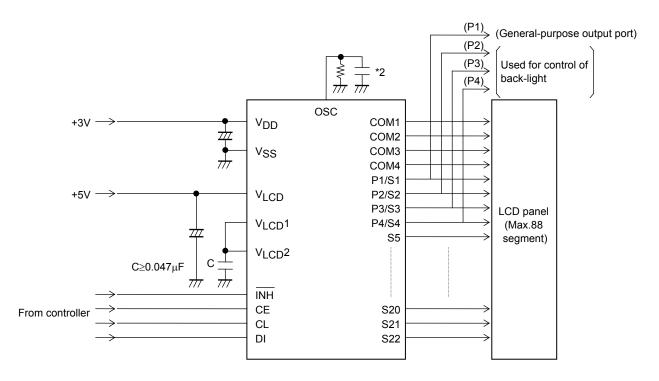


Note on Controller-used Display Data Transfer

Since the LC75844M is such that display data (D1 to D88) is transferred in 4 times, it is recommended to transfer display data within 30 [ms] in terms of display quality.

Sample Application Circuit 1

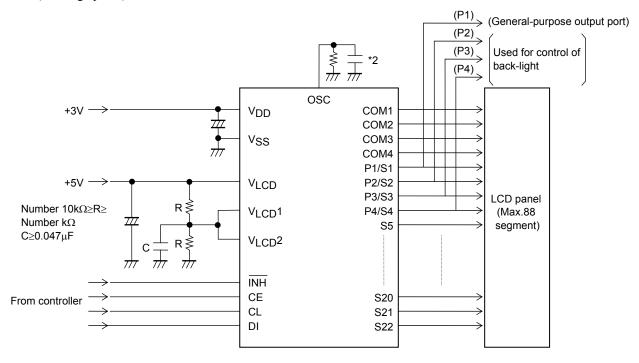
1/2 Bias (For normal panel)



*2 If a capacitor other than the external capacitor Cosc = 680 [pF] recommended is to be used, it is recommended to used a capacitor of 220 to 2200 [pF].

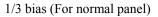
Sample Application Circuit 2

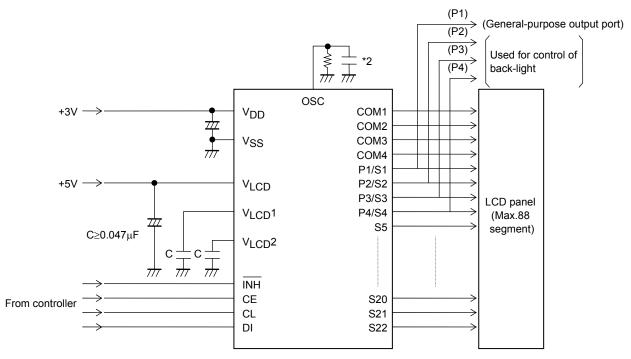
1/2 bias (For large panel)



*2 If a capacitor other than the external capacitor Cosc = 680 [pF] recommended is to be used, it is recommended to used a capacitor of 220 to 2200 [pF].

Sample Application Circuit 3

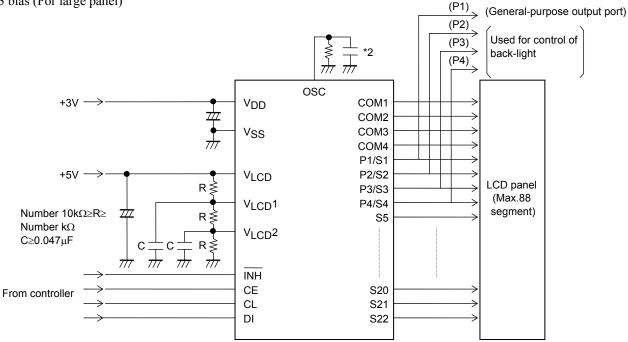




*2 If a capacitor other than the external capacitor Cosc = 680 [pF] recommended is to be used, it is recommended to used a capacitor of 220 to 2200 [pF].

Sample Application Circuit 4

1/3 bias (For large panel)



*2 If a capacitor other than the external capacitor Cosc = 680 [pF] recommended is to be used, it is recommended to used a capacitor of 220 to 2200 [pF].

ORDERING INFORMATION

Device	Package	Shipping (Qty / Packing)	
LC75844M-E	SOIC36 W / MFP36SDJ (375 mil) (Pb-Free)	25 / Fan-Fold	
LC75844M-TLM-E	SOIC36 W / MFP36SDJ (375 mil) (Pb-Free)	1000 / Tape & Reel	
LC75844MHS-MPB-E	SOIC36 W / MFP36SDJ (375 mil) (Pb-Free)	25 / Fan-Fold	
LC75844MHS-TLM-E	SOIC36 W / MFP36SDJ (375 mil) (Pb-Free)	1000 / Tape & Reel	

† For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D. http://www.onsemi.com/pub_link/Collateral/BRD8011-D.PDF

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